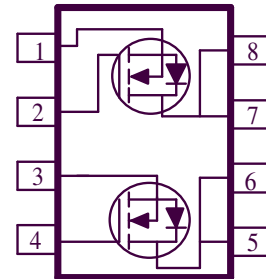
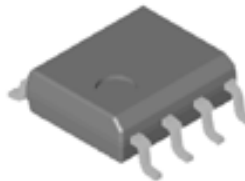


Dual N-Channel 40-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low $r_{DS(on)}$ provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe SOIC-8 saves board space
- Fast switching speed
- High performance trench technology



PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ m(Ω)	I_D (A)
40	22 @ $V_{GS} = 10V$	8.3
	27 @ $V_{GS} = 4.5V$	7.3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)			
Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^a	I_D	$T_A=25^\circ C$	8.3
		$T_A=70^\circ C$	6.8
Pulsed Drain Current ^b	I_{DM}	± 50	A
Continuous Source Current (Diode Conduction) ^a	I_S	2.3	A
Power Dissipation ^a	P_D	$T_A=25^\circ C$	2.1
		$T_A=70^\circ C$	1.3
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ C$

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Maximum	Units
Maximum Junction-to-Ambient ^a	$t \leq 10$ sec	62.5	$^\circ C/W$
	Steady-State	110	$^\circ C/W$

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

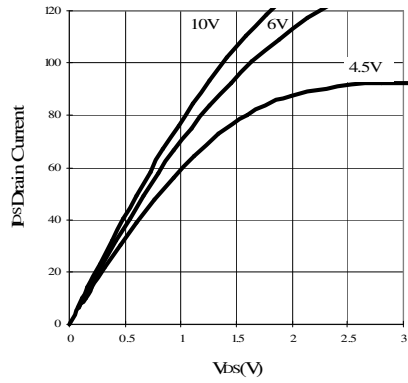
SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ	Max	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	30			V
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1			
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = 20\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 32\text{ V}, V_{GS} = 0\text{ V}$			1	uA
		$V_{DS} = 32\text{ V}, V_{GS} = 0\text{ V}, T_J = 55^\circ\text{C}$			25	
On-State Drain Current ^A	$I_{D(on)}$	$V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$	20			A
Drain-Source On-Resistance ^A	$r_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 8.3\text{ A}$			22	m Ω
		$V_{GS} = 4.5\text{ V}, I_D = 7.3\text{ A}$			27	
Forward Transconductance ^A	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 8.3\text{ A}$		40		S
Diode Forward Voltage	V_{SD}	$I_S = 2.3\text{ A}, V_{GS} = 0\text{ V}$		0.7		V
Pulsed Source Current (Body Diode) ^A	I_{SM}			5		A
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 15\text{ V}, V_{GS} = 5\text{ V},$ $I_D = 8.3\text{ A}$		20		nC
Gate-Source Charge	Q_{gs}			7		
Gate-Drain Charge	Q_{gd}			7		
Input Capacitance	C_{iss}	N-Channel $V_{DS}=20\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$		1317		pF
Output Capacitance	C_{oss}			272		
Reverse Transfer Capacitance	C_{rss}			169		
Turn-On Delay Time	$t_{d(on)}$			20		
Rise Time	t_r	$V_{DD} = 25\text{ V}, R_L = 25\text{ }\Omega, I_D = 1\text{ A},$ $V_{GEN} = 10\text{ V}$		9		nS
Turn-Off Delay Time	$t_{d(off)}$			70		
Fall-Time	t_f			20		

Notes

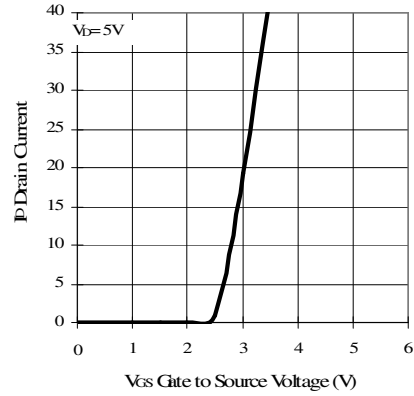
- Pulse test: $PW \leq 300\mu\text{s}$ duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

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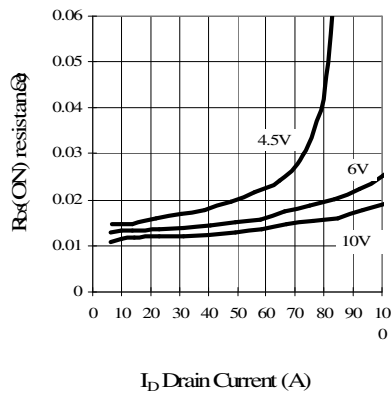
Typical Electrical Characteristics



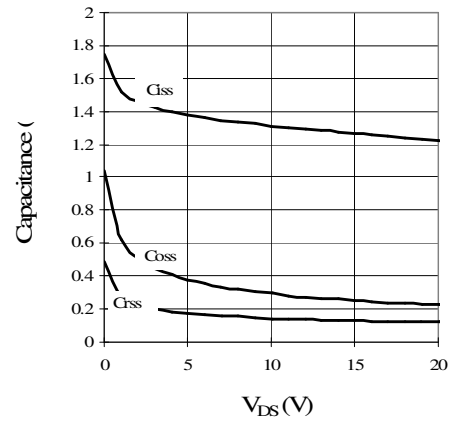
Output Characteristics



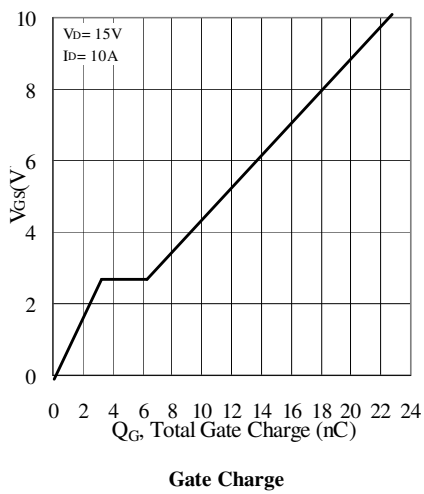
Transfer Characteristics



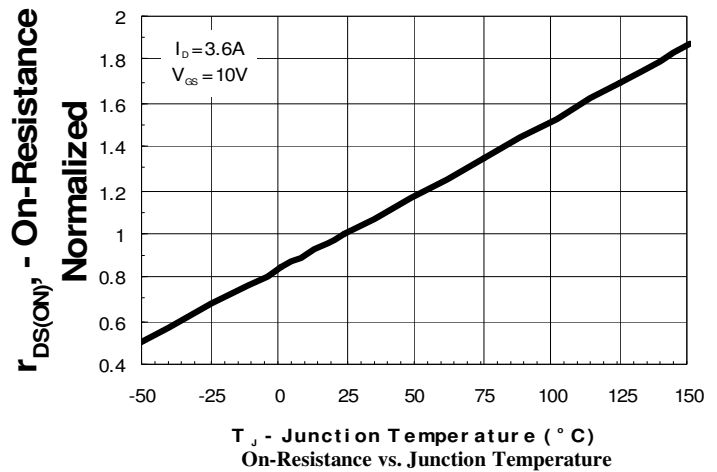
On-Resistance vs. Drain Current



Capacitance

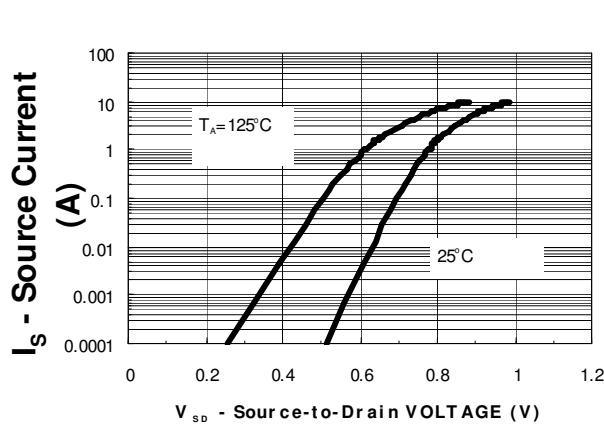


Gate Charge

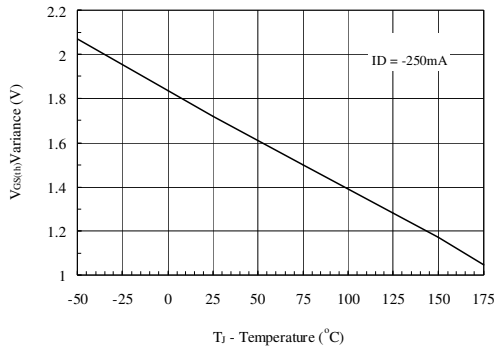


On-Resistance vs. Junction Temperature

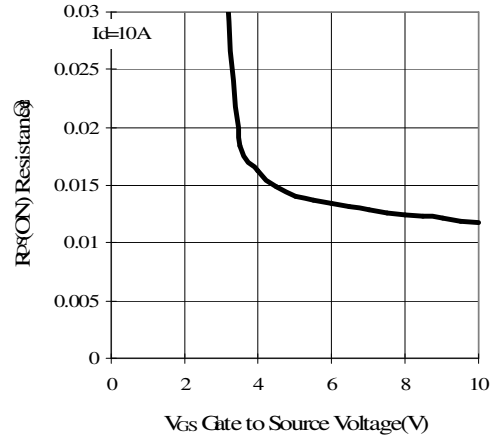
Typical Electrical Characteristics



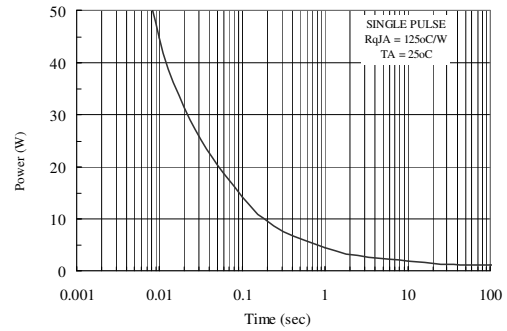
Source-Drain Diode Forward Voltage



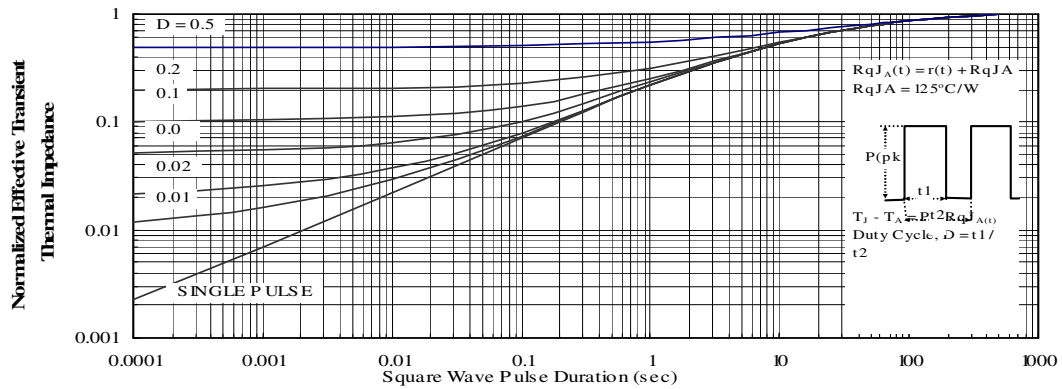
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



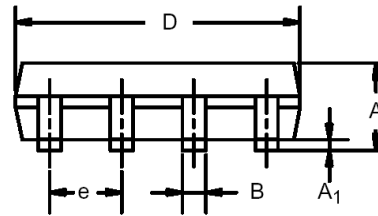
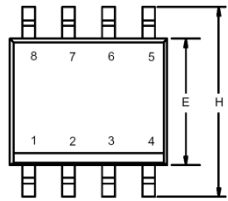
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient

Package Information

SO-8: 8LEAD



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°

